BEST ALUMNI STUDENT

12X6 Flexi Student Information

M.Manjusha VLSI Engineer (Back-End) Silicon Labs Bangalore

Package:10LPA

Regd No. – 15NM1A0464

Year of Admission - 2015



Ch.Manasa

VLSI Product Engineer Intel Corporation, California, USA Package - \$148K (1,14,68,002 Lac)



Name: Yamuna Prasanna Kumari

Company: Medicover tech

Designation : Senior Quality Engineer

Package: 17 LPA

Year of Admission: 2008



N. Saisha

Fresenisus Medical Care in California

Senior Electrical Engineer.

Package: \$155K (1,20,10,407 Per Annum)

Year of Admission: 2008



N.Harika

Tech Mahindra

Tech Lead

Package: 13.5LPA



8X4 Flexi

P.Chandana Sravani .Net Developer, HCL Chennai Package:8.5 LPA

Regd No. – 15NM1A0495

Year of Admission - 2015



P.Harika Application Associate Engineer Accenture Hyderabad

Package: 4.5Lac

Regd No. – 17NM1A04G1

Year of Admission - 2017

R.Ramya Associate system Engineer TCS, Hyderabad Package : 3.6Lac

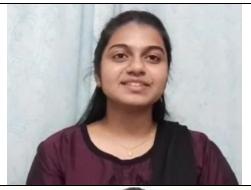
Regd No. – 16NM1A04C6

Year of Admission - 2016

M.Niharika Embedded Engineer Safran Aerospace Bangalore Package – 3.9Lac

Regd No. – 18NM5A0426

Year of Admission - 2017







Bhargavi Veeraghattam Pursuing Ph.D IIT, Kharagpur Nano Technology

Regd No. – 09NM1A0492

Year of Admission - 2009

D.Lalitha Sravani Embedded Engineer Visteon corporation Ltd Bangalore Package – 4Lac

Regd No. – 14NM1A0430

Year of Admission - 2014

B.Sri Kavya Associate Software Engineer Accenture Hyderabad Package – 4.5Lac

Regd No. – 17NM1A0418

Year of Admission - 2017



K.Sivani Java Developer TCS Chennai Package – 3.36LPA

Regd No. – 17NM1A04E8

Year of Admission - 2017

